## **DISCRETE SEMICONDUCTORS**

# DATA SHEET

## **PDTC144T series** NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = open

Product data sheet Supersedes data of 2004 Apr 06



## NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = open

### PDTC144T series

#### **FEATURES**

- Built-in bias resistors
- · Simplified circuit design
- Reduction of component count
- · Reduced pick and place costs.

#### **APPLICATIONS**

- General purpose switching and amplification
- · Inverter and interface circuits
- Circuit driver.

#### QUICK REFERENCE DATA

| SYMBOL    | PARAMETER                 | TYP. | MAX. | UNIT |
|-----------|---------------------------|------|------|------|
| $V_{CEO}$ | collector-emitter voltage | _    | 50   | V    |
| Io        | output current (DC)       | _    | 100  | mA   |
| R1        | bias resistor             | 47   | _    | kΩ   |
| R2        | open                      | _    | _    | _    |

#### **DESCRIPTION**

NPN resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

#### **PRODUCT OVERVIEW**

| TYPE NUMBER | PACK          | AGE    | MARKING CORE       | DND COMPLEMENT |
|-------------|---------------|--------|--------------------|----------------|
| TYPE NUMBER | PHILIPS       | EIAJ   | MARKING CODE       | PNP COMPLEMENT |
| PDTC144TE   | SOT416        | SC-75  | 43                 | PDTA144TE      |
| PDTC144TEF  | SOT490        | SC-89  | 33                 | PDTA144TEF     |
| PDTC144TK   | SOT346        | SC-59  | 53                 | PDTA144TK      |
| PDTC144TM   | SOT883        | SC-101 | E4                 | PDTA144TM      |
| PDTC144TS   | SOT54 (TO-92) | SC-43  | TC144T             | PDTA144TS      |
| PDTC144TT   | SOT23         | _      | *41 <sup>(1)</sup> | PDTA144TT      |
| PDTC144TU   | SOT323        | SC-70  | *41 <sup>(1)</sup> | PDTA144TU      |

#### Note

<sup>1. \* =</sup> p: Made in Hong Kong.

<sup>\* =</sup> t: Made in Malaysia.

<sup>\* =</sup> W: Made in China.

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## SIMPLIFIED OUTLINE, SYMBOL AND PINNING

| TYPE NUMBER  | CIMPLIFIED OUTLINE AND CYMPOL  | PINNING     |                              |  |  |
|--|--------------------------------|-------------|------------------------------|--|--|
| TYPE NUMBER  | SIMPLIFIED OUTLINE AND SYMBOL  | PIN         | DESCRIPTION                  |  |  |
| PDTC144TS  | 1 R1 R1 3 MAM361               | 1<br>2<br>3 | base<br>collector<br>emitter |  |  |
| PDTC144TE PDTC144TEF PDTC144TK PDTC144TT PDTC144TU | 3<br>1 R1 2<br>Top view MDB270 | 1<br>2<br>3 | base<br>emitter<br>collector |  |  |
| PDTC144TM  | 2 R1 3 Bottom view  MHC507     | 1 2 3       | base<br>emitter<br>collector |  |  |

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## PDTC144T series

#### **ORDERING INFORMATION**

| TYPE NUMBER | PACKAGE |   |         |  |  |  |  |  |
|-------------|---------|---|---------|--|--|--|--|--|
| TYPE NUMBER | NAME    | DESCRIPTION   | VERSION |  |  |  |  |  |
| PDTC144TE   | _       | plastic surface mounted package; 3 leads  | SOT416  |  |  |  |  |  |
| PDTC144TEF  | _       | plastic surface mounted package; 3 leads  | SOT490  |  |  |  |  |  |
| PDTC144TK   | _       | plastic surface mounted package; 3 leads  | SOT346  |  |  |  |  |  |
| PDTC144TM   | _       | leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.5 \text{ mm}$ | SOT883  |  |  |  |  |  |
| PDTC144TS   | _       | plastic single-ended leaded (through hole) package; 3 leads                                       | SOT54   |  |  |  |  |  |
| PDTC144TT   | _       | plastic surface mounted package; 3 leads  | SOT23   |  |  |  |  |  |
| PDTC144TU   | _       | plastic surface mounted package; 3 leads  | SOT323  |  |  |  |  |  |

### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL           | PARAMETER                     | CONDITIONS               | MIN. | MAX. | UNIT |
|------------------|-------------------------------|--------------------------|------|------|------|
| V <sub>CBO</sub> | collector-base voltage        | open emitter             | _    | 50   | V    |
| V <sub>CEO</sub> | collector-emitter voltage     | open base                | _    | 50   | V    |
| $V_{EBO}$        | emitter-base voltage          | open collector           | -    | 5    | V    |
| Io               | output current (DC)           |                          | _    | 100  | mA   |
| I <sub>CM</sub>  | peak collector current        |                          | _    | 100  | mA   |
| P <sub>tot</sub> | total power dissipation       | T <sub>amb</sub> ≤ 25 °C |      |      |      |
|                  | SOT54                         | note 1                   | _    | 500  | mW   |
|                  | SOT23                         | note 1                   | _    | 250  | mW   |
|                  | SOT346                        | note 1                   | _    | 250  | mW   |
|                  | SOT323                        | note 1                   | _    | 200  | mW   |
|                  | SOT490                        | notes 1 and 2            | _    | 250  | mW   |
|                  | SOT883                        | notes 2 and 3            | _    | 250  | mW   |
|                  | SOT416                        | note 1                   | _    | 150  | mW   |
| T <sub>stg</sub> | storage temperature           |                          | -65  | +150 | °C   |
| T <sub>j</sub>   | junction temperature          |                          | _    | 150  | °C   |
| T <sub>amb</sub> | operating ambient temperature |                          | -65  | +150 | °C   |

#### **Notes**

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60  $\mu m$  copper strip line.

## NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = open

## PDTC144T series

#### THERMAL CHARACTERISTICS

| SYMBOL               | PARAMETER                                   | CONDITIONS    | VALUE | UNIT |
|----------------------|---|---------------|-------|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air   |       |      |
|                      | SOT54                                       | note 1        | 250   | K/W  |
|                      | SOT23                                       | note 1        | 500   | K/W  |
|                      | SOT346                                      | note 1        | 500   | K/W  |
|                      | SOT323                                      | note 1        | 625   | K/W  |
|                      | SOT490                                      | notes 1 and 2 | 500   | K/W  |
|                      | SOT883                                      | notes 2 and 3 | 500   | K/W  |
|                      | SOT416                                      | note 1        | 833   | K/W  |

#### **Notes**

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60  $\mu m$  copper strip line.

#### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

| SYMBOL             | PARAMETER                            | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|--------------------|--------------------------------------|--|------|------|------|------|
| I <sub>CBO</sub>   | collector-base cut-off current       | $V_{CB} = 50 \text{ V}; I_{E} = 0 \text{ A}$                               | _    | _    | 100  | nA   |
| I <sub>CEO</sub>   | collector-emitter cut-off current    | $V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A}$                               | _    | _    | 1    | μΑ   |
|                    |                                      | $V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A}; T_{j} = 150 ^{\circ}\text{C}$ | _    | _    | 50   | μΑ   |
| I <sub>EBO</sub>   | emitter-base cut-off current         | $V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$                                | _    | _    | 100  | nA   |
| h <sub>FE</sub>    | DC current gain                      | V <sub>CE</sub> = 5 V; I <sub>C</sub> = 1 mA                               | 100  | _    | _    |      |
| V <sub>CEsat</sub> | collector-emitter saturation voltage | $I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$                                | _    | _    | 150  | mV   |
| R1                 | input resistor                       |  | 33   | 47   | 61   | kΩ   |
| C <sub>c</sub>     | collector capacitance                | $I_E = I_e = 0 \text{ A}; V_{CB} = 10 \text{ V};$<br>f = 1 MHz             | _    | _    | 2.5  | pF   |

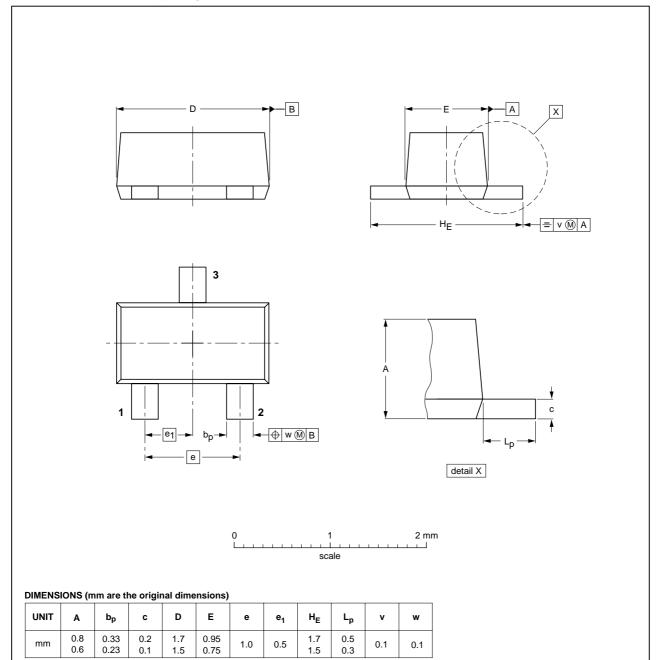
# NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = open

## PDTC144T series

#### **PACKAGE OUTLINES**

### Plastic surface-mounted package; 3 leads

SOT490

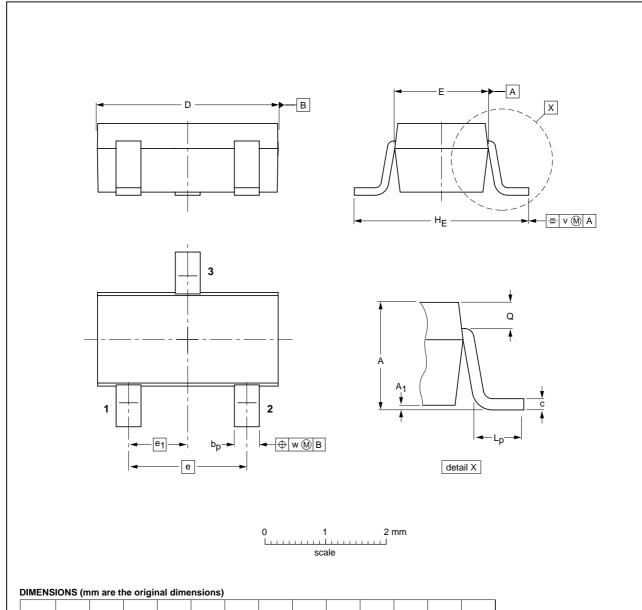


| OUTLINE |                      | KEFEK | ENCES      | EUROPEAN   | ISSUE DATE                      |  |  |
|---------|----------------------|-------|------------|------------|---------------------------------|--|--|
| VERSION | SION IEC JEDEC JEITA |       | PROJECTION | ISSUE DATE |                                 |  |  |
| SOT490  |                      |       | SC-89      |            | <del>05-07-28</del><br>06-03-16 |  |  |

## PDTC144T series

### Plastic surface-mounted package; 3 leads

SOT346



| UNIT | Α          | A <sub>1</sub> | bp           | С            | D          | E          | е   | e <sub>1</sub> | HE         | Lp         | Q            | v   | w   |
|------|------------|----------------|--------------|--------------|------------|------------|-----|----------------|------------|------------|--------------|-----|-----|
| mm   | 1.3<br>1.0 | 0.1<br>0.013   | 0.50<br>0.35 | 0.26<br>0.10 | 3.1<br>2.7 | 1.7<br>1.3 | 1.9 | 0.95           | 3.0<br>2.5 | 0.6<br>0.2 | 0.33<br>0.23 | 0.2 | 0.2 |

| OUTLINE |     | REFER  | ENCES  | EUROPEAN   | ISSUE DATE                      |  |
|---------|-----|--------|--------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC  | JEITA  | PROJECTION | ISSUE DATE                      |  |
| SOT346  |     | TO-236 | SC-59A |            | <del>04-11-11</del><br>06-03-16 |  |

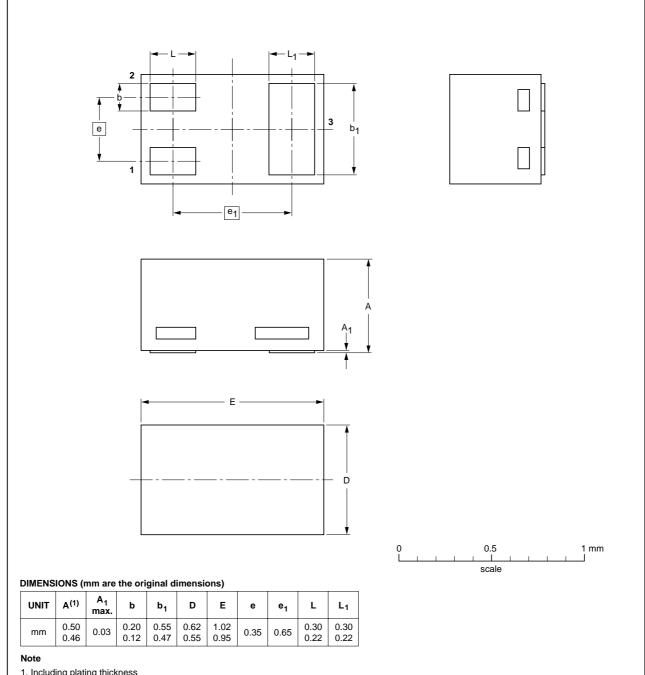
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## NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = open

## PDTC144T series

### Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

**SOT883** 



1. Including plating thickness

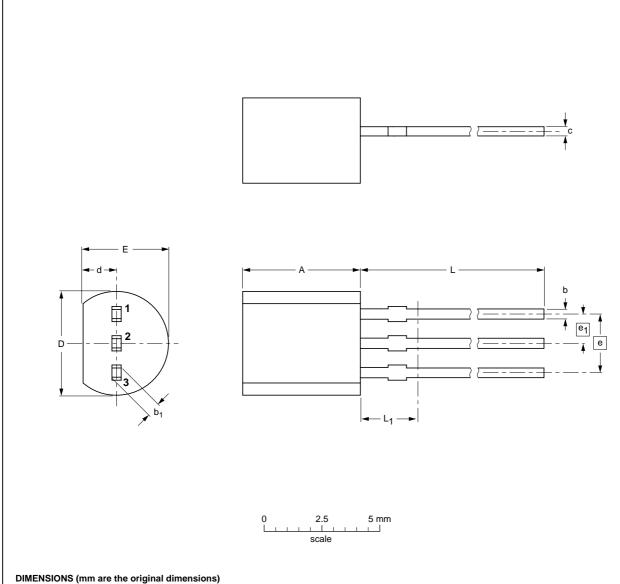
| OUTLINE<br>VERSION |     | REFER | RENCES | EUROPEAN   | ISSUE DATE                      |
|--------------------|-----|-------|--------|------------|---------------------------------|
|                    | IEC | JEDEC | JEITA  | PROJECTION | ISSUE DATE                      |
| SOT883             |     |       | SC-101 |            | <del>03-02-05</del><br>03-04-03 |

## NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = open

## PDTC144T series

### Plastic single-ended leaded (through hole) package; 3 leads

SOT54



| UNIT | Α          | b            | b <sub>1</sub> | С            | D          | d          | E          | е    | e <sub>1</sub> | L            | L <sub>1</sub> <sup>(1)</sup><br>max. |
|------|------------|--------------|----------------|--------------|------------|------------|------------|------|----------------|--------------|---------------------------------------|
| mm   | 5.2<br>5.0 | 0.48<br>0.40 | 0.66<br>0.55   | 0.45<br>0.38 | 4.8<br>4.4 | 1.7<br>1.4 | 4.2<br>3.6 | 2.54 | 1.27           | 14.5<br>12.7 | 2.5                                   |

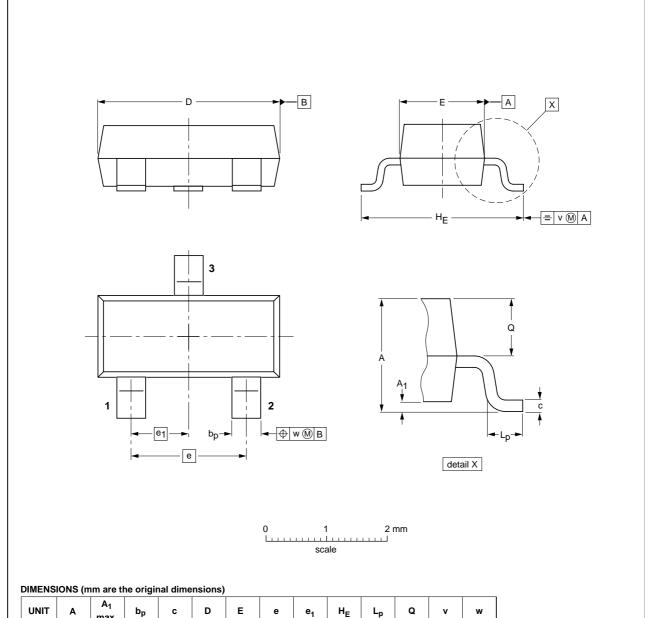
1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

| OUTLINE |     | REFER | EUROPEAN | ISSUE DATE |            |                                   |
|---------|-----|-------|----------|------------|------------|-----------------------------------|
| VERSION | IEC | JEDEC | JEITA    |            | PROJECTION | ISSUE DATE                        |
| SOT54   |     | TO-92 | SC-43A   |            |            | <del>-04-06-28-</del><br>04-11-16 |

## PDTC144T series

### Plastic surface-mounted package; 3 leads

SOT23



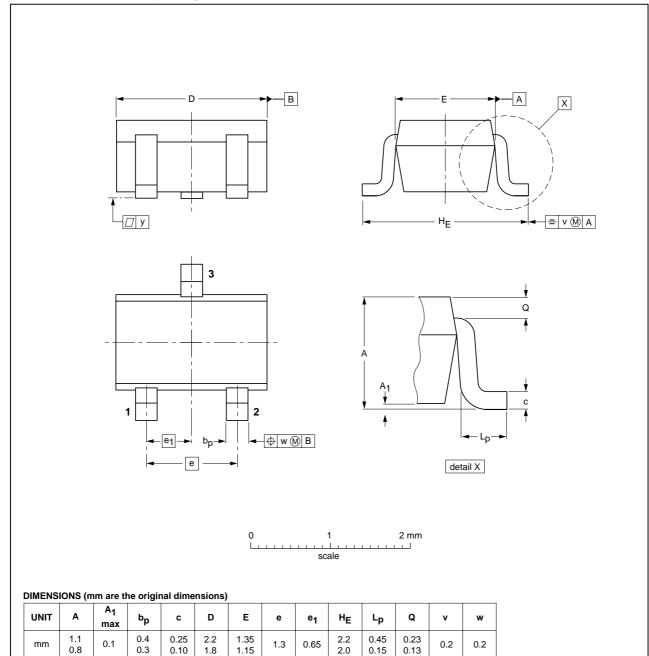
| UNIT | Α          | A <sub>1</sub><br>max. | bp           | С            | D          | E          | е   | e <sub>1</sub> | HE         | Lp           | Q            | v   | w   |
|------|------------|------------------------|--------------|--------------|------------|------------|-----|----------------|------------|--------------|--------------|-----|-----|
| mm   | 1.1<br>0.9 | 0.1                    | 0.48<br>0.38 | 0.15<br>0.09 | 3.0<br>2.8 | 1.4<br>1.2 | 1.9 | 0.95           | 2.5<br>2.1 | 0.45<br>0.15 | 0.55<br>0.45 | 0.2 | 0.1 |

| OUTLINE |     | REFER    | EUROPEAN | ICCUE DATE |            |                                  |
|---------|-----|----------|----------|------------|------------|----------------------------------|
| VERSION | IEC | JEDEC    | JEITA    |            | PROJECTION | ISSUE DATE                       |
| SOT23   |     | TO-236AB |          |            |            | <del>-04-11-04</del><br>06-03-16 |

## PDTC144T series

### Plastic surface-mounted package; 3 leads

**SOT323** 

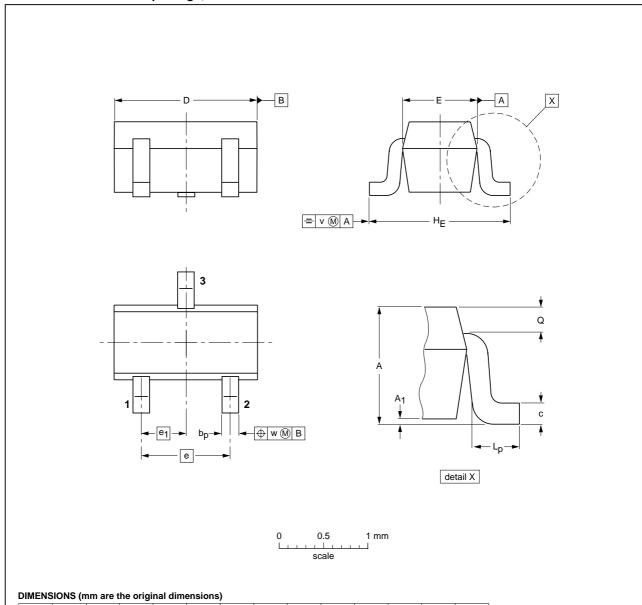


| OUTLINE |     | REFER | EUROPEAN | ISSUE DATE |            |                                 |
|---------|-----|-------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA    |            | PROJECTION | ISSUE DATE                      |
| SOT323  |     |       | SC-70    |            |            | <del>04-11-04</del><br>06-03-16 |

## PDTC144T series

### Plastic surface-mounted package; 3 leads

**SOT416** 



| U | NIT | Α            | A <sub>1</sub><br>max | bp           | С            | D          | E          | е | e <sub>1</sub> | HE           | Lp           | ø            | v   | w   |
|---|-----|--------------|-----------------------|--------------|--------------|------------|------------|---|----------------|--------------|--------------|--------------|-----|-----|
| n | nm  | 0.95<br>0.60 | 0.1                   | 0.30<br>0.15 | 0.25<br>0.10 | 1.8<br>1.4 | 0.9<br>0.7 | 1 | 0.5            | 1.75<br>1.45 | 0.45<br>0.15 | 0.23<br>0.13 | 0.2 | 0.2 |

| OUTLINE |     | REFER | EUROPEAN | ISSUE DATE |            |                                 |
|---------|-----|-------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA    |            | PROJECTION | ISSUE DATE                      |
| SOT416  |     |       | SC-75    |            |            | <del>04-11-04</del><br>06-03-16 |

## NPN resistor-equipped transistors; R1 = 47 k $\Omega$ , R2 = open

### PDTC144T series

#### **DATA SHEET STATUS**

| DOCUMENT<br>STATUS <sup>(1)</sup> | PRODUCT<br>STATUS <sup>(2)</sup> | DEFINITION  |
|-----------------------------------|----------------------------------|---|
| Objective data sheet              | Development                      | This document contains data from the objective specification for product development. |
| Preliminary data sheet            | Qualification                    | This document contains data from the preliminary specification.                       |
| Product data sheet                | Production                       | This document contains the product specification.                                     |

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